Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I²C, LINbus, SIO, SSU, UART/USART
Peripherals	LCD, POR, PWM, Voltage Detect, WDT
Number of I/O	56
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	3.5K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2la68anfa-30

1.1.3   Specifications

Tables 1.6 to 1.8 list the specifications.

Table 1.6   Specifications (1)

Item	Function		Specification

CPU	Central processing unit		R8C CPU core
			• Number of fundamental instructions: 89
			• Minimum instruction execution time:
			  50 ns (f(XIN) = 20 MHz, VCC = 2.7 V to 5.5 V)
			  125 ns (f(XIN) = 8 MHz, VCC = 1.8 V to 5.5 V)
			• Multiplier: 16 bits × 16 bits → 32 bits
			• Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits
			• Operating mode: Single-chip mode (address space: 1 Mbyte)

Memory	ROM/RAM Data flash		Refer to Tables 1.9 to 1.12 Product Lists.
Power Supply Voltage Detection	Voltage detection circuit		• Power-on reset • Voltage detection 3 (detection level of voltage detection 0 and voltage detection 1 selectable)
I/O Ports	Programmable I/O ports	R8C/LA3A Group	• CMOS I/O ports: 26, selectable pull-up resistor [(1)] • High current drive ports: 8
		R8C/LA5A Group	• CMOS I/O ports: 44, selectable pull-up resistor [(1)] • High current drive ports: 8
		R8C/LA6A Group	• CMOS I/O ports: 56, selectable pull-up resistor [(1)] • High current drive ports: 8
		R8C/LA8A Group	• CMOS I/O ports: 72, selectable pull-up resistor [(1)] • High current drive ports: 10

Clock	Clock generation circuits		4 circuits: XIN clock oscillation circuit
			             XCIN clock oscillation circuit (32 kHz)
			             High-speed on-chip oscillator (with frequency adjustment function)
			             Low-speed on-chip oscillator
			• Oscillation stop detection:
			  XIN clock oscillation stop detection function
			• Frequency divider circuit:
			  Division ratio selectable from 1, 2, 4, 8, and 16
			• Low-power-consumption modes:
			  Standard operating mode (high-speed clock, low-speed clock, high-speed on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode, power-off mode

			Real-time clock (timer RH)
Interrupts	R8C/LA3A Group		• Number of interrupt vectors: 69 • External Interrupt: 13 ($\overline{\text{INT}}$ × 5, key input × 8) • Priority levels: 7 levels
	R8C/LA5A Group		• Number of interrupt vectors: 69 • External Interrupt: 14 ($\overline{\text{INT}}$ × 6, key input × 8) • Priority levels: 7 levels
	R8C/LA6A Group R8C/LA8A Group		• Number of interrupt vectors: 69 • External Interrupt: 16 ($\overline{\text{INT}}$ × 8, key input × 8) • Priority levels: 7 levels
Watchdog Timer			• 14 bits × 1 (with prescaler) • Selectable reset start function • Selectable low-speed on-chip oscillator for watchdog timer

Note:
  1. No pull-up resistor is provided in the pins P5_4 to P5_6.

Table 1.7   Specifications (2)

Item	Function		Specification		
Timer	Timer RB0, Timer RB1		8 bits × 2 (with 8-bit prescaler) Timer mode (period timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode		
	Timer RC		16 bits × 1 (with 4 capture/compare registers) Timer mode (input capture function, output compare function), PWM mode (output: 3 pins), PWM2 mode (PWM output: 1 pin)		
	Timer RH		Real-time clock mode (counting of seconds, minutes, hours, day of the week, date, month, year), output compare mode		
	Timer RJ0 Timer RJ1 Timer RJ2	R8C/LA3A Group	Timer RJ0, Timer RJ1	16 bits × 2	Timer mode (period timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode
		R8C/LA5A Group			
		R8C/LA6A Group			
		R8C/LA8A Group	Timer RJ0, Timer RJ1, Timer RJ2	16 bits × 3	
Serial Interface	UART0		1 channel Clock synchronous serial I/O/UART		
	UART2		1 channel Clock synchronous serial I/O/UART, I^{2}C mode (I^{2}C-bus), multiprocessor communication function		
Synchronous Serial Communication Unit (SSU)			1 (shared with I^{2}C-bus)		
I^{2}C bus			1 (shared with SSU)		
A/D Converter	R8C/LA3A Group		10-bit resolution × 5 channels, including sample and hold function, with sweep mode, temperature sensor included (measurement temperature range: −20 to 85 °C (N version)/ −40 to 85 °C (D version))		
	R8C/LA5A Group		10-bit resolution × 7 channels, including sample and hold function, with sweep mode, temperature sensor included (measurement temperature range: −20 to 85 °C (N version)/ −40 to 85 °C (D version))		
	R8C/LA6A Group		10-bit resolution × 8 channels, including sample and hold function, with sweep mode, temperature sensor included (measurement temperature range: −20 to 85 °C (N version)/ −40 to 85 °C (D version))		
	R8C/LA8A Group		10-bit resolution × 12 channels, including sample and hold function, with sweep mode, temperature sensor included (measurement temperature range: −20 to 85 °C (N version)/ −40 to 85 °C (D version))		
Comparator B	R8C/LA3A Group		1 circuit (comparator B1)		
	R8C/LA5A Group		2 circuits (comparator B1, comparator B3)		
	R8C/LA6A Group				
	R8C/LA8A Group				

1.2   Product Lists

Tables 1.9 to 1.12 list product information for each group. Figures 1.1 to 1.4 show the Correspondence of Part No., with Memory Size and Package for each group.

Table 1.9   Product List for R8C/LA3A Group   **Current of Oct 2011**

Part No.	Internal ROM Capacity		Internal RAM Capacity	Package Type	Remarks
	Program ROM	Data Flash			
R5F2LA32ANFP	8 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0032GB-A	N Version
R5F2LA34ANFP	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0032GB-A	
R5F2LA36ANFP	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0032GB-A	
R5F2LA38ANFP	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0032GB-A	
R5F2LA32ADFP	8 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0032GB-A	D Version
R5F2LA34ADFP	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0032GB-A	
R5F2LA36ADFP	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0032GB-A	
R5F2LA38ADFP	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0032GB-A	

Part No. R 5 F 2L A3 8 A N FP

Package type:
   FP: LQFP (0.8 mm pin-pitch)

Classification
   N: Operating ambient temperature −20 to 85°C
   D: Operating ambient temperature −40 to 85°C

DataFlash
   A: DataFlash

ROM capacity
   2: 8KB
   4: 16KB
   6: 32KB
   8: 64KB

R8C/LA3A Group

R8C/Lx Series

Memory type
   F: Flash memory
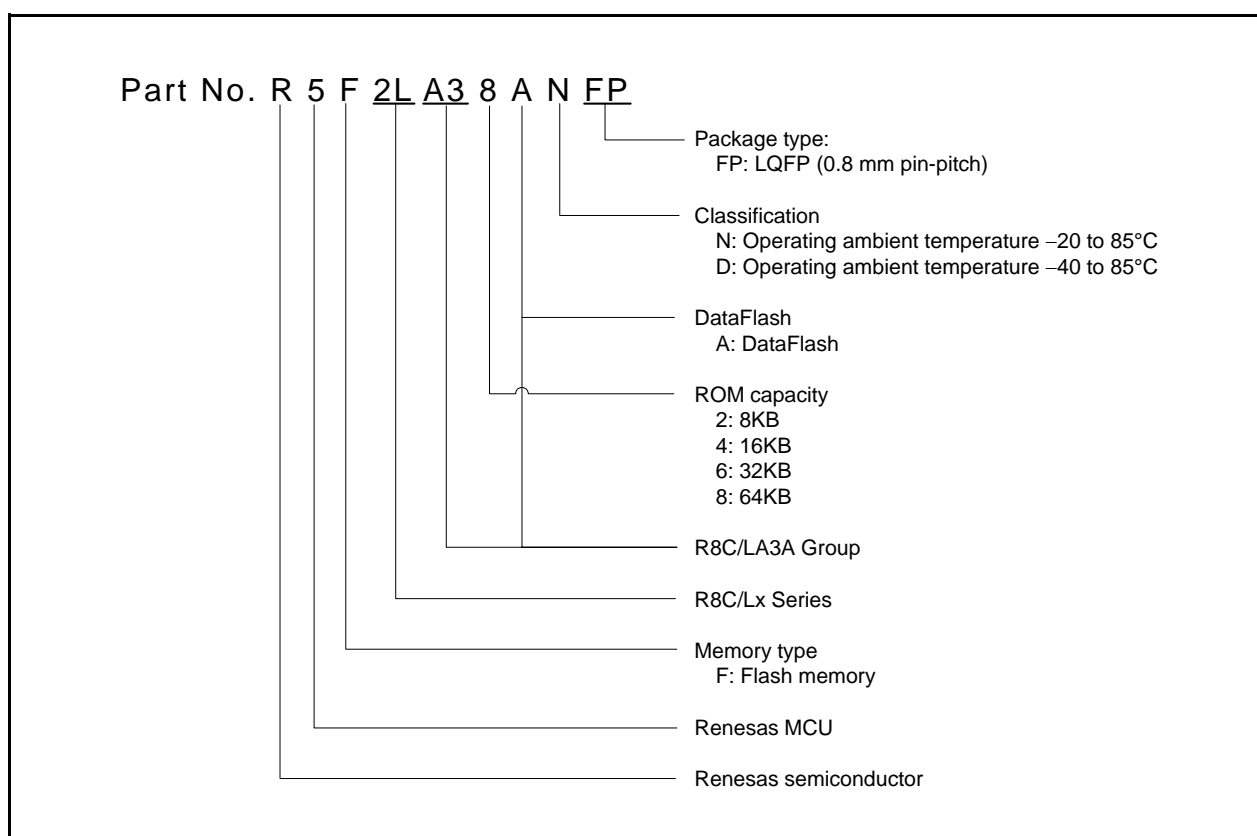
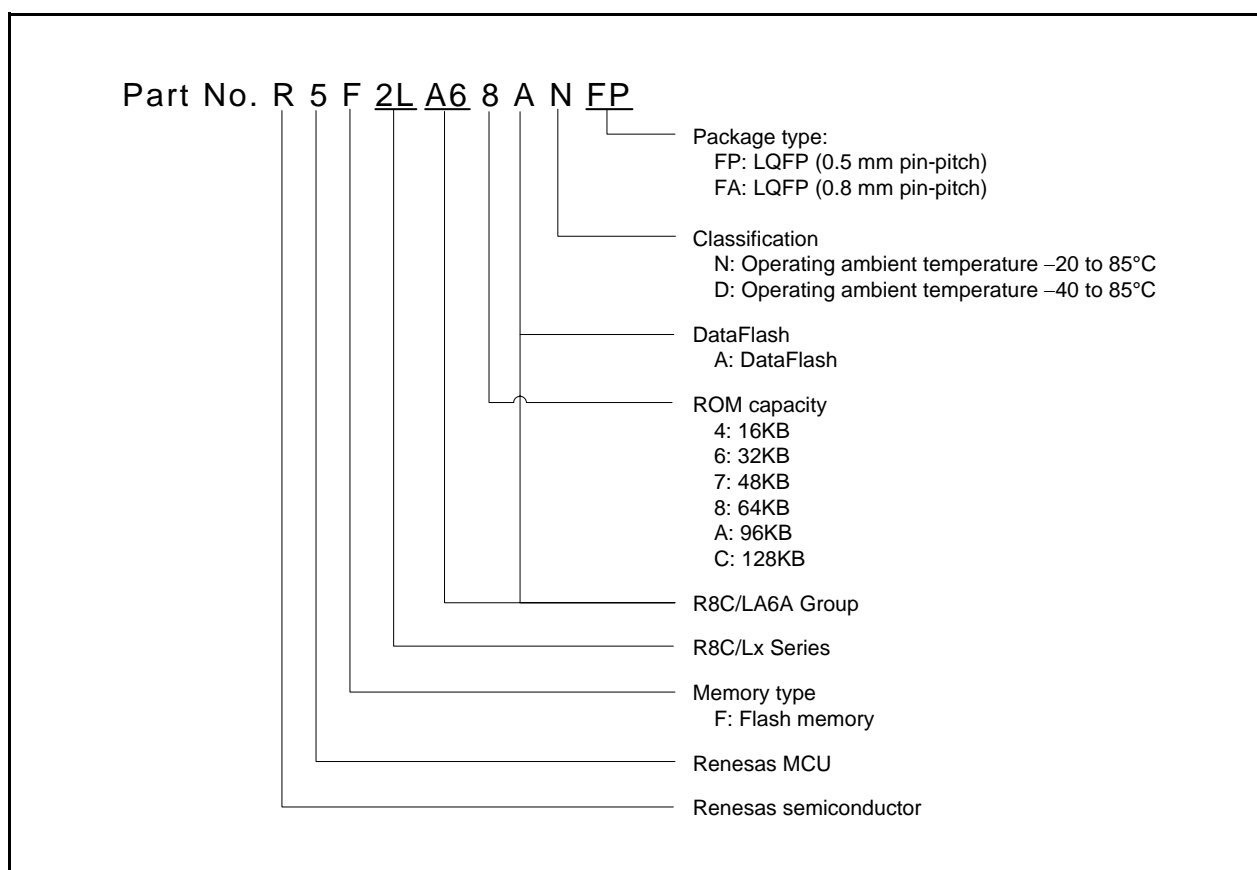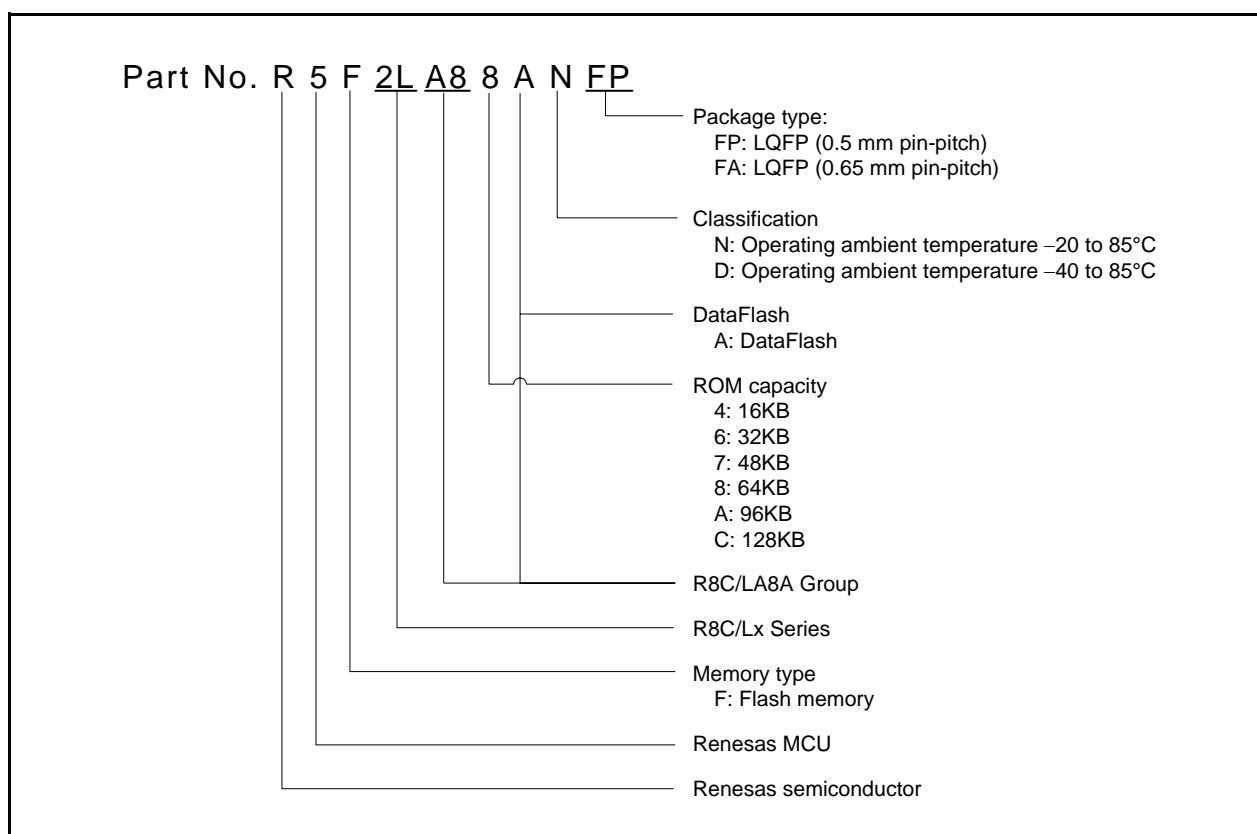Renesas MCU

Renesas semiconductor

Figure 1.1   Correspondence of Part No., with Memory Size and Package of R8C/LA3A Group

Table 1.11 Product List for R8C/LA6A Group **Current of Oct 2011**

Part No.	Internal ROM Capacity		Internal RAM Capacity	Package Type	Remarks
	Program ROM	Data Flash			
R5F2LA64ANFP	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0064KB-A	N Version
R5F2LA64ANFA	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0064GA-A	
R5F2LA66ANFP	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0064KB-A	
R5F2LA66ANFA	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0064GA-A	
R5F2LA67ANFP	48 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0064KB-A	
R5F2LA67ANFA	48 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0064GA-A	
R5F2LA68ANFP	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0064KB-A	
R5F2LA68ANFA	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0064GA-A	
R5F2LA6AANFP	96 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0064KB-A	
R5F2LA6AANFA	96 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0064GA-A	
R5F2LA6CANFP	128 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0064KB-A	
R5F2LA6CANFA	128 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0064GA-A	
R5F2LA64ADFP	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0064KB-A	D Version
R5F2LA64ADFA	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0064GA-A	
R5F2LA66ADFP	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0064KB-A	
R5F2LA66ADFA	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0064GA-A	
R5F2LA67ADFP	48 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0064KB-A	
R5F2LA67ADFA	48 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0064GA-A	
R5F2LA68ADFP	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0064KB-A	
R5F2LA68ADFA	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0064GA-A	
R5F2LA6AADFP	96 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0064KB-A	
R5F2LA6AADFA	96 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0064GA-A	
R5F2LA6CADFP	128 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0064KB-A	
R5F2LA6CADFA	128 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0064GA-A	

Part No. R 5 F 2L A6 8 A N FP

Package type:
  FP: LQFP (0.5 mm pin-pitch)
  FA: LQFP (0.8 mm pin-pitch)

Classification
  N: Operating ambient temperature −20 to 85°C
  D: Operating ambient temperature −40 to 85°C

DataFlash
  A: DataFlash

ROM capacity
  4: 16KB
  6: 32KB
  7: 48KB
  8: 64KB
  A: 96KB
  C: 128KB

R8C/LA6A Group

R8C/Lx Series

Memory type
  F: Flash memory

Renesas MCU

Renesas semiconductor

Figure 1.3 Correspondence of Part No., with Memory Size and Package of R8C/LA6A Group

Table 1.12   Product List for R8C/LA8A Group   **Current of Oct 2011**

Part No.	Internal ROM Capacity		Internal RAM Capacity	Package Type	Remarks
	Program ROM	Data Flash			
R5F2LA84ANFP	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0080KB-A	N Version
R5F2LA84ANFA	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0080JA-A	
R5F2LA86ANFP	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0080KB-A	
R5F2LA86ANFA	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0080JA-A	
R5F2LA87ANFP	48 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0080KB-A	
R5F2LA87ANFA	48 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0080JA-A	
R5F2LA88ANFP	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0080KB-A	
R5F2LA88ANFA	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0080JA-A	
R5F2LA8AANFP	96 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0080KB-A	
R5F2LA8AANFA	96 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0080JA-A	
R5F2LA8CANFP	128 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0080KB-A	
R5F2LA8CANFA	128 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0080JA-A	
R5F2LA84ADFP	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0080KB-A	D Version
R5F2LA84ADFA	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0080JA-A	
R5F2LA86ADFP	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0080KB-A	
R5F2LA86ADFA	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0080JA-A	
R5F2LA87ADFP	48 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0080KB-A	
R5F2LA87ADFA	48 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0080JA-A	
R5F2LA88ADFP	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0080KB-A	
R5F2LA88ADFA	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0080JA-A	
R5F2LA8AADFP	96 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0080KB-A	
R5F2LA8AADFA	96 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0080JA-A	
R5F2LA8CADFP	128 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0080KB-A	
R5F2LA8CADFA	128 Kbytes	2 Kbytes × 2	5.5 Kbytes	PLQP0080JA-A	

Part No. R 5 F 2L A8 8 A N FP

Package type:
  FP: LQFP (0.5 mm pin-pitch)
  FA: LQFP (0.65 mm pin-pitch)

Classification
  N: Operating ambient temperature −20 to 85°C
  D: Operating ambient temperature −40 to 85°C

DataFlash
  A: DataFlash

ROM capacity
  4: 16KB
  6: 32KB
  7: 48KB
  8: 64KB
  A: 96KB
  C: 128KB

R8C/LA8A Group

R8C/Lx Series

Memory type
  F: Flash memory

Renesas MCU

Renesas semiconductor

Figure 1.4   Correspondence of Part No., with Memory Size and Package of R8C/LA8A Group
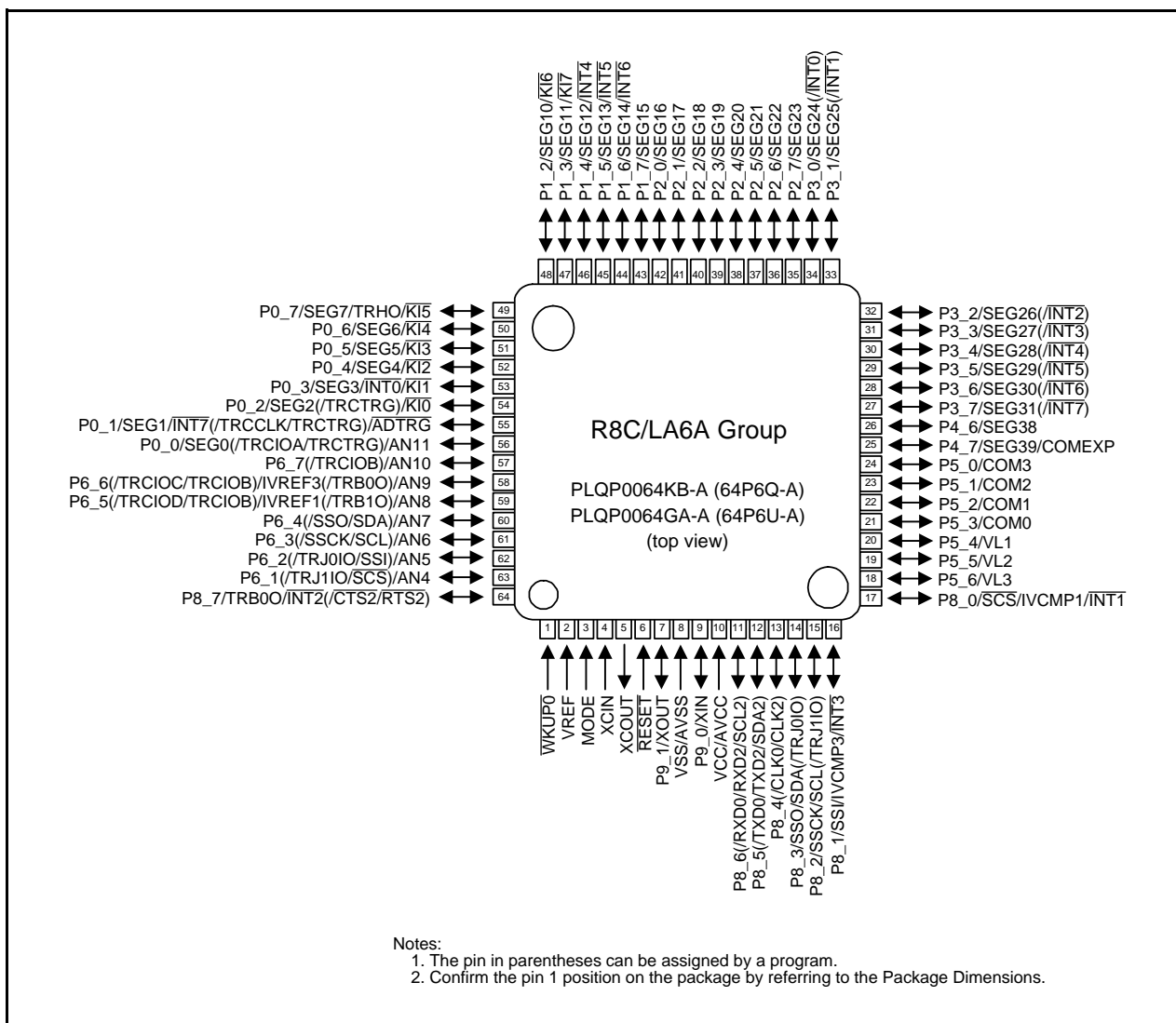
Figure 1.11   Pin Assignment (Top View) of PLQP0064KB-A and PLQP0064GA-A Packages

Table 1.15   Pin Name Information by Pin Number (R8C/LA6A Group, R8C/LA8A Group)(1)

| Pin Number | | Control Pin | Port | I/O Pin Functions for Peripheral Modules | | | | | | |
LA8A	LA6A			Interrupt	Timer	Serial Interface	SSU	I^{2}C bus	A/D Converter, Comparator B	LCD drive Control Circuit
1			P7_1		TRJ1O	(TXD2/SDA2/RXD2/SCL2)				
2		$\overline{\text{WKUP1}}$	P7_0		TRJ2O	(CLK2)				
3	64		P8_7	$\overline{\text{INT2}}$	TRB0O	$\overline{\text{(CTS2/RTS2)}}$				
4	1	$\overline{\text{WKUP0}}$								
5	2	VREF								
6	3	MODE								
7	4	XCIN								
8	5	XCOUT								
9	6	$\overline{\text{RESET}}$								
10	7	XOUT	P9_1							
11	8	VSS/ AVSS								
12	9	XIN	P9_0							
13	10	VCC/ AVCC								
14	11		P8_6			(RXD0/RXD2/SCL2)				
15	12		P8_5			(TXD0/TXD2/SDA2)				
16	13		P8_4			(CLK0/CLK2)				
17	14		P8_3		(TRJ0IO)		SSO	SDA		
18	15		P8_2		(TRJ1IO)		SSCK	SCL		
19	16		P8_1	$\overline{\text{INT3}}$			SSI		IVCMP3	
20	17		P8_0	$\overline{\text{INT1}}$			$\overline{\text{SCS}}$		IVCMP1	
21	18		P5_6							VL3
22	19		P5_5							VL2
23	20		P5_4							VL1
24	21		P5_3							COM0
25	22		P5_2							COM1
26	23		P5_1							COM2
27	24		P5_0							COM3
28	25		P4_7							SEG39/ COMEXP
29	26		P4_6							SEG38
30			P4_5							SEG37

Note:
1. The pin in parentheses can be assigned by a program.

1.5   Pin Functions

Tables 1.18 and 1.19 list Pin Functions for R8C/LA5A Group, and Tables 1.20 and 1.21 list Pin Functions for R8C/LA8A Group.

Table 1.18   Pin Functions for R8C/LA5A Group (1)

Item	Pin Name	I/O Type	Description
Power supply input	VCC, VSS	—	Apply 1.8 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	—	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	$\overline{\text{RESET}}$	I	Driving this pin low resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
Power-off 0 mode exit input	$\overline{\text{WKUP0}}$	I	This pin is provided for input to exit the mode used in power-off 0 mode. Connect to VSS when not using power-off 0 mode.
	$\overline{\text{WKUP1}}$	I	This pin is provided for input to exit the mode used in power-off 0 mode.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic oscillator or a crystal oscillator between pins XIN and XOUT. [1] To use an external clock, input it to the XIN pin and set XOUT as the I/O port P9_1. When the pin is not used, treat it as an unassigned pin and use the appropriate handling.
XIN clock output	XOUT	O	
XCIN clock input	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between pins XCIN and XCOUT. [1] To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.
XCIN clock output	XCOUT	O	
$\overline{\text{INT}}$ interrupt input	$\overline{\text{INT0}}$ to $\overline{\text{INT3}}$, $\overline{\text{INT5}}$, $\overline{\text{INT7}}$	I	$\overline{\text{INT}}$ interrupt input pins.
Key input interrupt	$\overline{\text{KI0}}$ to $\overline{\text{KI7}}$	I	Key input interrupt input pins.
Timer RB	TRB0O, TRB1O	O	Timer RB output pins.
Timer RC	TRCCLK	I	External clock input pin.
	TRCTRG	I	External trigger input pin.
	TRCIOA, TRCIOB, TRCIOC, TRCIOD	I/O	Timer RC I/O pins.
Timer RH	TRHO	O	Timer RH output pin.
Timer RJ	TRJ0IO, TRJ1IO	I/O	Timer RJ I/O pins.
Serial interface	CLK0	I/O	Transfer clock I/O pin.
	RXD0	I	Serial data input pin.
	TXD0	O	Serial data output pin.

I: Input   O: Output   I/O: Input and output
Note:
   1. Contact the oscillator manufacturer for oscillation characteristics.

2.8.7   Interrupt Enable Flag (I)

The I flag enables maskable interrupts.
Interrupts are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8   Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.
The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.8.9   Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7.
If a requested interrupt has higher priority than IPL, the interrupt is enabled.

2.8.10   Reserved Bit

If necessary, set to 0. When read, the content is undefined.

Table 4.2   SFR Information for R8C/LA5A Group (2) [(1)]

Address	Register	Symbol	After Reset
003Ah	Voltage Monitor 2 Circuit Control Register	VW2C	10000010b
003Bh			
003Ch			
003Dh			
003Eh			
003Fh			
0040h			
0041h	Flash Memory Ready Interrupt Control Register	FMRDYIC	XXXXX000b
0042h			
0043h	INT7 Interrupt Control Register	INT7IC	XX00X000b
0044h			
0045h	INT5 Interrupt Control Register	INT5IC	XX00X000b
0046h			
0047h	Timer RC Interrupt Control Register	TRCIC	XXXXX000b
0048h			
0049h			
004Ah	Timer RH Interrupt Control Register	TRHIC	XXXXX000b
004Bh			
004Ch			
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	SSU Interrupt Control Register / IIC bus Interrupt Control Register [(2)]	SSUIC/IICIC	XXXXX000b
0050h			
0051h	UART0 Transmit Interrupt Control Register	S0TIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	S0RIC	XXXXX000b
0053h			
0054h			
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RJ0 Interrupt Control Register	TRJ0IC	XXXXX000b
0057h	Timer RB1 Interrupt Control Register	TRB1IC	XXXXX000b
0058h	Timer RB0 Interrupt Control Register	TRB0IC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh	Timer RJ1 Interrupt Control Register	TRJ1IC	XXXXX000b
005Ch			
005Dh	INT0 Interrupt Control Register	INT0IC	XX00X000b
005Eh			
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah	LCD Interrupt Control Register	LCDIC	XXXXX000b
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h			
0071h			
0072h	Voltage monitor 1 Interrupt Control Register	VCMP1IC	XXXXX000b
0073h	Voltage monitor 2 Interrupt Control Register	VCMP2IC	XXXXX000b
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Fh			

X: Undefined

Notes:
1. Blank spaces are reserved. No access is allowed.
2. Selectable by the IICSEL bit in the SSUIICSR register.

Table 4.5   SFR Information for R8C/LA5A Group (5) [1]

Address	Register	Symbol	After Reset
0100h			
0101h			
0102h			
0103h			
0104h			
0105h			
0106h			
0107h			
0108h	Timer RB0 Control Register	TRB0CR	00h
0109h	Timer RB0 One-Shot Control Register	TRB0OCR	00h
010Ah	Timer RB0 I/O Control Register	TRB0IOC	00h
010Bh	Timer RB0 Mode Register	TRB0MR	00h
010Ch	Timer RB0 Prescaler Register	TRB0PRE	FFh
010Dh	Timer RB0 Secondary Register	TRB0SC	FFh
010Eh	Timer RB0 Primary Register	TRB0PR	FFh
010Fh			
0110h	Timer RH Second Data Register / Counter Data Register	TRHSEC	XXh 00h [2]
0111h	Timer RH Minute Data Register / Compare Data Register	TRHMIN	XXh 00h [2]
0112h	Timer RH Hour Data Register	TRHHR	00XXXXXXb 00h [2]
0113h	Timer RH Day-of-the-Week Data Register	TRHWK	00000XXXb 00h [2]
0114h	Timer RH Date Data Register	TRHDY	00XXXXXXb 00000001b [2]
0115h	Timer RH Month Data Register	TRHMON	000XXXXXb 00000001b [2]
0116h	Timer RH Year Data Register	TRHYR	XXh 00h [2]
0117h	Timer RH Control Register	TRHCR	XXX00X0Xb 000XX1X0b [2]
0118h	Timer RH Count Source Select Register	TRHCSR	X0001000b 0XXXXXXXb [2]
0119h	Timer RH Clock Error Correction Register	TRHADJ	XXh 00h [2]
011Ah	Timer RH Interrupt Flag Register	TRHIFR	00000XXXb 000XX000b [2]
011Bh	Timer RH Interrupt Enable Register	TRHIER	XXh 00h [2]
011Ch	Timer RH Alarm Minute Register	TRHAMN	XXh 00h [2]
011Dh	Timer RH Alarm Hour Register	TRHAHR	XXh 00h [2]
011Eh	Timer RH Alarm Day-of-the-Week Register	TRHAWK	X0000XXXb 00h [2]
011Fh	Timer RH Protect Register	TRHPRC	00h X0000000b [2]
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0122h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0123h	Timer RC Status Register	TRCSR	01110000b
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0126h	Timer RC Counter	TRC	00h
0127h			00h
0128h	Timer RC General Register A	TRCGRA	FFh
0129h			FFh
012Ah	Timer RC General Register B	TRCGRB	FFh
012Bh			FFh
012Ch	Timer RC General Register C	TRCGRC	FFh
012Dh			FFh
012Eh	Timer RC General Register D	TRCGRD	FFh
012Fh			FFh
0130h	Timer RC Control Register 2	TRCCR2	00011000b
0131h	Timer RC Digital Filter Function Select Register	TRCDF	00h
0132h	Timer RC Output Master Enable Register	TRCOER	01111111b
0133h	Timer RC Trigger Control Register	TRCADCR	00h
0134h			
0135h			
0136h			
0137h			
0138h			
0139h			
013Ah			
013Bh			
013Ch			
013Dh			
013Eh			
013Fh			

X: Undefined
Notes:
1. Blank spaces are reserved. No access is allowed.
2. This is the reset value after reset by RTCRST bit in TRHCR register.

Table 4.17   SFR Information for R8C/LA8A Group (8) [1]

Address	Register	Symbol	After Reset
01C0h	Address Match Interrupt Register 0	RMAD0	XXh
01C1h			XXh
01C2h			0000XXXXb
01C3h	Address Match Interrupt Enable Register 0	AIER0	00h
01C4h	Address Match Interrupt Register 1	RMAD1	XXh
01C5h			XXh
01C6h			0000XXXXb
01C7h	Address Match Interrupt Enable Register 1	AIER1	00h
01C8h			
01C9h			
01CAh			
01CBh			
01CCh			
01CDh			
01CEh			
01CFh			
01D0h			
01D1h			
01D2h			
01D3h			
01D4h			
01D5h			
01D6h			
01D7h			
01D8h			
01D9h			
01DAh			
01DBh			
01DCh			
01DDh			
01DEh			
01DFh			
01E0h	Port P0 Pull-Up Control Register	P0PUR	00h
01E1h	Port P1 Pull-Up Control Register	P1PUR	00h
01E2h	Port P2 Pull-Up Control Register	P2PUR	00h
01E3h	Port P3 Pull-Up Control Register	P3PUR	00h
01E4h	Port P4 Pull-Up Control Register	P4PUR	00h
01E5h	Port P5 Pull-Up Control Register	P5PUR	00h
01E6h	Port P6 Pull-Up Control Register	P6PUR	00h
01E7h	Port P7 Pull-Up Control Register	P7PUR	00h
01E8h	Port P8 Pull-Up Control Register	P8PUR	00h
01E9h	Port P9 Pull-Up Control Register	P9PUR	00h
01EAh			
01EBh			
01ECh			
01EDh			
01EEh			
01EFh			
01F0h	Port P7 Drive Capacity Control Register	P7DRR	00h
01F1h	Port P8 Drive Capacity Control Register	P8DRR	00h
01F2h			
01F3h			
01F4h			
01F5h	Input Threshold Control Register 0	VLT0	00h
01F6h	Input Threshold Control Register 1	VLT1	00h
01F7h	Input Threshold Control Register 2	VLT2	00h
01F8h	Comparator B Control Register 0	INTCMP	00h
01F9h			
01FAh	External Input Enable Register 0	INTEN	00h
01FBh	External Input Enable Register 1	INTEN1	00h
01FCh	INT Input Filter Select Register 0	INTF	00h
01FDh	INT Input Filter Select Register 1	INTF1	00h
01FEh	Key Input Enable Register 0	KIEN	00h
01FFh	Key Input Enable Register 1	KIEN1	00h

X: Undefined
Note:
   1. Blank spaces are reserved. No access is allowed.

Table 4.18   SFR Information for R8C/LA8A Group (9) [(1)]

Address	Register	Symbol	After Reset
0200h	LCD Control Register	LCR0	00h
0201h			
0202h	LCD Option Clock Control Register	LCR2	00h
0203h	LCD Clock Control Register	LCR3	00h
0204h	LCD Display Control Register	LCR4	00h
0205h			
0206h	LCD Port Select Register 0	LSE0	00h
0207h	LCD Port Select Register 1	LSE1	00h
0208h	LCD Port Select Register 2	LSE2	00h
0209h	LCD Port Select Register 3	LSE3	00h
020Ah	LCD Port Select Register 4	LSE4	00h
020Bh	LCD Port Select Register 5	LSE5	00h
020Ch			
020Dh			
020Eh			
020Fh			
0210h	LCD Display Data Register	LRA0L	XXh
0211h		LRA1L	XXh
0212h		LRA2L	XXh
0213h		LRA3L	XXh
0214h		LRA4L	XXh
0215h		LRA5L	XXh
0216h		LRA6L	XXh
0217h		LRA7L	XXh
0218h		LRA8L	XXh
0219h		LRA9L	XXh
021Ah		LRA10L	XXh
021Bh		LRA11L	XXh
021Ch		LRA12L	XXh
021Dh		LRA13L	XXh
021Eh		LRA14L	XXh
021Fh		LRA15L	XXh
0220h		LRA16L	XXh
0221h		LRA17L	XXh
0222h		LRA18L	XXh
0223h		LRA19L	XXh
0224h		LRA20L	XXh
0225h		LRA21L	XXh
0226h		LRA22L	XXh
0227h		LRA23L	XXh
0228h		LRA24L	XXh
0229h		LRA25L	XXh
022Ah		LRA26L	XXh
022Bh		LRA27L	XXh
022Ch		LRA28L	XXh
022Dh		LRA29L	XXh
022Eh		LRA30L	XXh
022Fh		LRA31L	XXh
0230h		LRA32L	XXh
0231h		LRA33L	XXh
0232h		LRA34L	XXh
0233h		LRA35L	XXh
0234h		LRA36L	XXh
0235h		LRA37L	XXh
0236h		LRA38L	XXh
0237h		LRA39L	XXh
:			
2FFFh			

X: Undefined
Note:
    1. Blank spaces are reserved. No access is allowed.

Table 5.19   DC Characteristics (2) [4.0 V ≤ Vcc ≤ 5.5 V]
(T_opr = −20 to 85 °C (N version)/ −40 to 85 °C (D version), unless otherwise specified.)

Symbol	Parameter		Oscillation Circuit		On-Chip Oscillator		CPU Clock	Low-Power-Consumption Setting	Other		Min.	Typ. (3)	Max.	Unit
			XIN (2)	XCIN	High-Speed	Low-Speed								
Icc	Power supply current (1)	High-speed clock mode	20 MHz	Off	Off	125 kHz	No division	–			–	4.7	10	mA
			16 MHz	Off	Off	125 kHz	No division	–			–	3.9	8	mA
			10 MHz	Off	Off	125 kHz	No division	–			–	2.3	–	mA
			20 MHz	Off	Off	Off	No division	FMR27 = 1 MSTCR0 = BEh MSTCR1 = 3Fh	Flash memory off Program operation on RAM Module standby setting enabled		–	3.1	–	mA
			20 MHz	Off	Off	125 kHz	Divide-by-8	–			–	1.8	–	mA
			16 MHz	Off	Off	125 kHz	Divide-by-8	–			–	1.5	–	mA
			10 MHz	Off	Off	125 kHz	Divide-by-8	–			–	1.0	–	mA
		High-speed on-chip oscillator mode	Off	Off	20 MHz	125 kHz	No division	–			–	5.0	11	mA
			Off	Off	20 MHz	125 kHz	Divide-by-8	–			–	2.1	–	mA
			Off	Off	4 MHz	125 kHz	Divide-by-16	MSTCR0 = BEh MSTCR1 = 3Fh			–	0.9	–	mA
		Low-speed on-chip oscillator mode	Off	Off	Off	125 kHz	No division	FMR27 = 1 VCA20 = 0			–	110	320	μA
			Off	Off	Off	125 kHz	Divide-by-8	FMR27 = 1 VCA20 = 0			–	63	220	μA
		Low-speed clock mode	Off	32 kHz	Off	Off	No division	FMR27 = 1 VCA20 = 0			–	60	220	μA
			Off	32 kHz	Off	Off	No division	FMSTP = 1 VCA20 = 0	Flash memory off Program operation on RAM		–	46	–	μA
		Wait mode	Off	Off	Off	125 kHz	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1	While a WAIT instruction is executed Peripheral clock operation		–	9.0	50	μA
			Off	Off	Off	125 kHz	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off		–	2.8	33	μA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 0	While a WAIT instruction is executed Peripheral clock off Timer RH operation in real-time clock mode	LCD drive control circuit (4) When external division resistors are used	–	4.6	–	μA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off Timer RH operation in real-time clock mode		–	2.4	–	μA
		Stop mode	Off	Off	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 25 °C Peripheral clock off		–	0.5	2.2	μA
			Off	Off	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 85 °C Peripheral clock off		–	1.2	–	μA
		Power-off mode	Off	Off	Off	Off	–	–	Power-off 0 Topr = 25 °C		–	0.01	0.1	μA
			Off	Off	Off	Off	–	–	Power-off 0 Topr = 85 °C		–	0.03	–	μA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Power-off 2 Topr = 25 °C		–	1.8	6.4	μA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Power-off 2 Topr = 85 °C		–	2.7	–	μA

Notes:
1. Vcc = 4.0 V to 5.5 V, single chip mode, output pins are open, and other pins are Vss.
2. XIN is set to square wave input.
3. Vcc = 5.0 V
4. VLCD = Vcc, external division resistors are used for VL3 to VL1, 1/3 bias, 1/4 duty, f(FR) = 64 Hz, SEG0 to SEG26 are selected, and segment and common output pins are open. The standard value does not include the current that flows through external division resistors.

Table 5.23   DC Characteristics (6) [1.8 V ≤ Vcc < 2.7 V]
(T_{opr} = −20 to 85 °C (N version)/ −40 to 85 °C (D version), unless otherwise specified.)

Symbol	Parameter		Oscillation Circuit XIN [2]	Oscillation Circuit XCIN	On-Chip Oscillator High-Speed	On-Chip Oscillator Low-Speed	CPU Clock	Low-Power-Consumption Setting	Other		Min.	Typ. [3]	Max.	Unit
Icc	Power supply current [1]	High-speed clock mode	8 MHz	Off	Off	125 kHz	No division	−			−	2.1	−	mA
			8 MHz	Off	Off	125 kHz	Divide-by-8	−			−	0.9	−	mA
		High-speed on-chip oscillator mode	Off	Off	5 MHz	125 kHz	No division	−			−	1.8	5	mA
			Off	Off	5 MHz	125 kHz	Divide-by-8	−			−	1.1	−	mA
			Off	Off	4 MHz	125 kHz	Divide-by-16	MSTCR0 = BEh MSTCR1 = 3Fh			−	0.9	−	mA
		Low-speed on-chip oscillator mode	Off	Off	Off	125 kHz	No division	FMR27 = 1 VCA20 = 0			−	106	300	μA
			Off	Off	Off	125 kHz	Divide-by-8	FMR27 = 1 VCA20 = 0			−	54	200	μA
		Low-speed clock mode	Off	32 kHz	Off	Off	No division	FMR27 = 1 VCA20 = 0			−	54	200	μA
			Off	32 kHz	Off	Off	No division	FMSTP = 1 VCA20 = 0	Flash memory off Program operation on RAM		−	36	−	μA
		Wait mode	Off	Off	Off	125 kHz	−	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1	While a WAIT instruction is executed Peripheral clock operation		−	9.0	50	μA
			Off	Off	Off	125 kHz	−	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off		−	2.5	31	μA
			Off	32 kHz	Off	Off	−	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 0	While a WAIT instruction is executed Peripheral clock off Timer RH operation in real-time clock mode	LCD drive control circuit [4] When external division resistors are used	−	2.4	−	μA
			Off	32 kHz	Off	Off	−	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off Timer RH operation in real-time clock mode		−	1.7	−	μA
		Stop mode	Off	Off	Off	Off	−	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 25 °C Peripheral clock off		−	0.5	2.2	μA
			Off	Off	Off	Off	−	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 85 °C Peripheral clock off		−	1.2	−	μA
		Power-off mode	Off	Off	Off	Off	−	−	Power-off 0 Topr = 25 °C		−	0.01	0.1	μA
			Off	Off	Off	Off	−	−	Power-off 0 Topr = 85 °C		−	0.02	−	μA
			Off	32 kHz	Off	Off	−	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Power-off 2 Topr = 25 °C		−	1.2	4	μA
			Off	32 kHz	Off	Off	−	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Power-off 2 Topr = 85 °C		−	2	−	μA

Notes:
1. Vcc = 1.8 V to 2.7 V, single chip mode, output pins are open, and other pins are Vss.
2. XIN is set to square wave input.
3. Vcc = 2.2 V
4. VLCD = Vcc, external division resistors are used for VL3 to VL1, 1/3 bias, 1/4 duty, f(FR) = 64 Hz, SEG0 to SEG26 are selected, and segment and common output pins are open.The standard value does not include the current that flows through external division resistors.

Table 5.45   **LCD Drive Control Circuit Characteristics**
(V$_{CC}$ = 1.8 to 5.5 V, V$_{SS}$ = 0 V, and T$_{opr}$ = -20 to 85$°$C (N version)/ -40 to 85$°$C (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
VLCD	LCD power supply voltage	VLCD = VL3	2.2	–	5.5	V
VL2	VL2 voltage		VL1	–	VL3	V
VL1	VL1 voltage		1	–	VL2 [2]	V
f(FR)	Frame frequency		50	–	180	Hz
ILCD	LCD drive control circuit current		–	[1]	–	μA

Notes:
1. Refer to Table 5.48 DC Characteristics (2), Table 5.50 DC Characteristics (4), and Table 5.52 DC Characteristics (6).
2. The VL1 voltage should be VCC or below.

Table 5.46   **Power-Off Mode Characteristics**
(V$_{CC}$ = 1.8 to 5.5 V, V$_{SS}$ = 0 V, and T$_{opr}$ = -20 to 85$°$C (N version)/ -40 to 85$°$C (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
–	Power-off mode operating supply voltage		1.8	–	5.5	V

Table 5.50   DC Characteristics (4) [2.7 V ≤ Vcc < 4.0 V]
(Topr = −20 to 85°C (N version)/ −40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Oscillation Circuit		On-Chip Oscillator		CPU Clock	Low-Power-Consumption Setting	Other	Min.	Typ. (3)	Max.	Unit
			XIN (2)	XCIN	High-Speed	Low-Speed							
Icc	Power supply current (1)	High-speed clock mode	20 MHz	Off	Off	125 kHz	No division	–		–	4.7	10	mA
			10 MHz	Off	Off	125 kHz	No division	–		–	2.3	6	mA
			20 MHz	Off	Off	Off	No division	FMR27 = 1 MSTCR0 = BEh MSTCR1 = 3Fh	Flash memory off Program operation on RAM Module standby setting enabled	–	2.9	–	mA
			20 MHz	Off	Off	125 kHz	Divide-by-8	–		–	1.8	–	mA
			10 MHz	Off	Off	125 kHz	Divide-by-8	–		–	1.0	–	mA
		High-speed on-chip oscillator mode	Off	Off	20 MHz	125 kHz	No division	–		–	5.0	11	mA
			Off	Off	20 MHz	125 kHz	Divide-by-8	–		–	2.1	–	mA
			Off	Off	10 MHz	125 kHz	No division	–		–	2.9	–	mA
			Off	Off	10 MHz	125 kHz	Divide-by-8	–		–	1.5	–	mA
			Off	Off	4 MHz	125 kHz	Divide-by-16	MSTCR0 = BEh MSTCR1 = 3Fh		–	0.9	–	mA
		Low-speed on-chip oscillator mode	Off	Off	Off	125 kHz	No division	FMR27 = 1 VCA20 = 0		–	106	300	µA
			Off	Off	Off	125 kHz	Divide-by-8	FMR27 = 1 VCA20 = 0		–	54	200	µA
		Low-speed clock mode	Off	32 kHz	Off	Off	No division	FMR27 = 1 VCA20 = 0		–	54	200	µA
			Off	32 kHz	Off	Off	No division	FMSTP = 1 VCA20 = 0	Flash memory off Program operation on RAM	–	36	–	µA
		Wait mode	Off	Off	Off	125 kHz	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1	While a WAIT instruction is executed Peripheral clock operation	–	9.0	50	µA
			Off	Off	Off	125 kHz	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off	–	2.5	31	µA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 0	While a WAIT instruction is executed Peripheral clock off Timer RH operation in real-time clock mode / LCD drive control circuit (4) When external division resistors are used	–	3.1	–	µA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off Timer RH operation in real-time clock mode	–	1.7	–	µA
		Stop mode	Off	Off	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 25°C Peripheral clock off	–	0.5	2.2	µA
			Off	Off	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 85°C Peripheral clock off	–	1.2	–	µA
		Power-off mode	Off	Off	Off	Off	–	–	Power-off 0 Topr = 25°C	–	0.01	0.1	µA
			Off	Off	Off	Off	–	–	Power-off 0 Topr = 85°C	–	0.02	–	µA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Power-off 2 Topr = 25°C	–	1.3	4.5	µA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Power-off 2 Topr = 85°C	–	2.2	–	µA

Notes:
1. Vcc = 2.7 V to 4.0 V, single chip mode, output pins are open, and other pins are Vss.
2. XIN is set to square wave input.
3. Vcc = 3.0 V
4. VLCD = Vcc, external division resistors are used for VL3 to VL1, 1/3 bias, 1/4 duty, f(FR) = 64 Hz, SEG0 to SEG39 are selected, and segment and common output pins are open. The standard value does not include the current that flows through external division resistors.
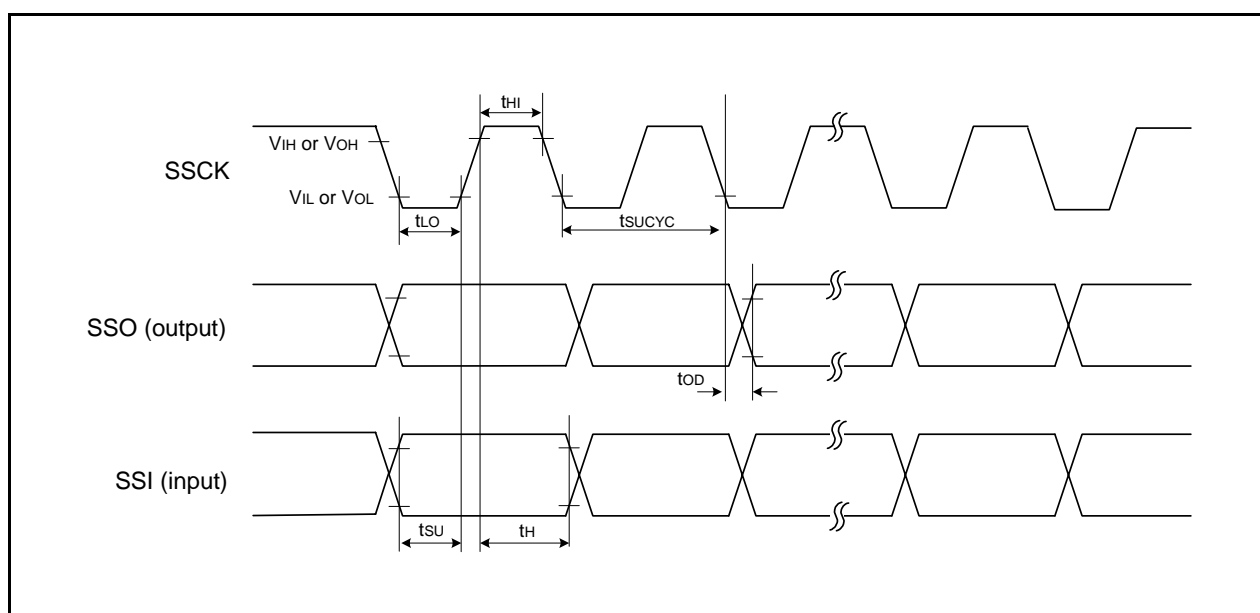
Figure 5.17   I/O Timing of Synchronous Serial Communication Unit (SSU) (Clock Synchronous Communication Mode)

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

   Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

   — The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

RENESAS

Renesas Electronics Corporation

http://www.renesas.com